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FAIRCHILD

SEMICONDUCTOR®

FMG2G300LS60E

Molding Type Module

General Description

Fairchild IGBT Power Module provides low conduction as well as short circuit ruggedness. It's designed for the applications such as welder.

Features

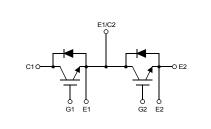
- Short Circuit Rated Time; 10us @ T_C =100°C, V_{GE} = 15V
- Low Saturation Voltage: V_{CE(Sat)} = 1.4 V @ I_C = 300A
- High Input Impedance
- Fast & Soft Anti-Parallel FWD
- UL Certified No.E209204

Application

· AC/ DC Welder



Package Code : 7PM-HA



Internal Circuit Diagram

Symbol	Description	FMG2G300LS60E	Units	
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Collector Current		300	А
I _{CM (1)}	Pulsed Collector Current		600	А
I _F	Diode Continuous Forward Current		300	А
I _{FM}	Diode Maximum Forward Current		600	А
P _D	Maximum Power Dissipation		892	W
T _{SC}	Short Circuit Withstand Time	@ T _C = 100°C	10	us
TJ	Operating Junction Temperature		-40 to +150	°C
T _{STG}	Storage Temperature Range		-40 to +125	°C
V _{ISO}	Isolation Voltage	@ AC 1minute	2500	V
Mounting Torque	Power Terminal Screw : M5		4.0	N.m
Mounting Torque	Mounting Screw : M6		4.0	N.m

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

IGBT

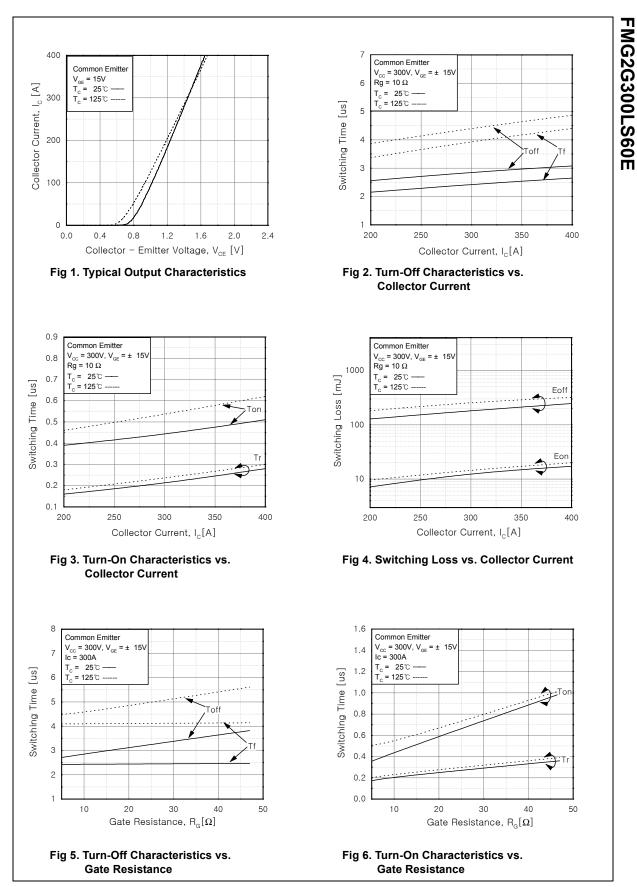
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	600			V
ΔB _{VCES} / ΔT _J	Temperature Coeff. of Breakdown Voltage	$V_{GE} = 0V, I_C = 1mA$		0.6		V/∘C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I _{GES}	Gate - Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Cha V _{GE(th)} V _{CE(sat)}	racteristics Gate - Emitter Threshold Voltage Collector to Emitter Saturation Voltage	I_{C} = 300mA, V_{CE} = V_{GE} I_{C} = 300A, V_{GE} = 15V	5.0	6.5 1.4	8.5 1.8	V V
	ng Characteristics Turn-On Delay Time	_		0.23		us
				0.23		us us
t _r	Turn-On Delay Time	$V_{CC} = 300 \text{ V}, \text{ I}_{C} = 300 \text{ A},$				
t _r t _{d(off)} t _f	Turn-On Delay Time Rise Time	R _G = 10Ω, V _{GE} = 15V,		0.21		us
t _{d(on)} t _r t _{d(off)} t _f E _{on}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss			0.21 0.43 2.43 13		us us us mJ
t _r t _{d(off)} t _f E _{on}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss	R _G = 10Ω, V _{GE} = 15V,		0.21 0.43 2.43 13 180		us us us
t _r t _{d(off)} t _f E _{on} E _{off} t _{d(on)}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-On Delay Time	R _G = 10Ω, V _{GE} = 15V,	 	0.21 0.43 2.43 13 180 0.3	 	us us mJ mJ us
t <u>r</u> t <u>d(off)</u> t <u>f</u> E _{on} E _{off} t <u>d(on)</u> tr	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-On Delay Time Rise Time	$R_G = 10\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$	 	0.21 0.43 2.43 13 180 0.3 0.23	 	us us mJ mJ us us
t <u>r</u> t <u>d(off)</u> Eon Eoff t <u>d(on)</u> tr t_d(off)	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Turn-Off Delay Time	$R_G = 10\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$ $V_{CC} = 300$ V, $I_C = 300$ A,	 	0.21 0.43 2.43 13 180 0.3 0.23 0.46	 	us us mJ mJ us us us
t <u>r</u> t <u>d(off)</u> Eon Eoff t <u>d(on)</u> tr t <u>d(off)</u> t _f	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-Off Delay Time Fall Time	$R_G = 10\Omega$, $V_{GE} = 15V$, Inductive Load, $T_C = 25^{\circ}C$	 	0.21 0.43 2.43 13 180 0.3 0.23 0.46 4.1	 	US US MJ MJ US US US
t <u>r</u> t <u>d(off)</u> Eon Eoff t <u>d(on)</u> t <u>r</u> t <u>d(off)</u> t <u>f</u> Eon	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-Off Delay Time Fall Time Turn-On Switching Loss	$R_{G} = 10\Omega, V_{GE} = 15V,$ Inductive Load, $T_{C} = 25^{\circ}C$ $V_{CC} = 300 V, I_{C} = 300A,$ $R_{G} = 10\Omega, V_{GE} = 15V,$	 	0.21 0.43 2.43 13 180 0.3 0.23 0.46 4.1 15	 	us us mJ us us us us us us
t <u>r</u> t <u>d(off)</u> Eon Eoff t <u>d(on)</u> tr t <u>d(off)</u> t _f	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-Off Delay Time Fall Time	$R_{G} = 10\Omega, V_{GE} = 15V,$ Inductive Load, T _C = 25°C $V_{CC} = 300 V, I_{C} = 300A,$ $R_{G} = 10\Omega, V_{GE} = 15V,$ Inductive Load, T _C = 125°C	 	0.21 0.43 2.43 13 180 0.3 0.23 0.46 4.1	 	us us mJ mJ us us us us
t <u>r</u> t <u>d(off)</u> t <u>f</u> Eon Eoff t <u>d(on)</u> t <u>r</u> t <u>d(off)</u> t <u>f</u> Eon Eoff T _{sc}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Short Circuit Withstand Time	$R_{G} = 10\Omega, V_{GE} = 15V,$ Inductive Load, $T_{C} = 25^{\circ}C$ $V_{CC} = 300 V, I_{C} = 300A,$ $R_{G} = 10\Omega, V_{GE} = 15V,$	 	0.21 0.43 2.43 13 180 0.3 0.23 0.46 4.1 15 260 	 	us us mJ mJ us us us us mJ mJ us
tr td(off) tf Eon Eoff td(on) tr td(off) tf Eon Eoff Tsc Qg	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-Off Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-Off Switching Loss Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-Off Switching Loss Total Gate Charge	$\begin{split} &R_{G} = 10\Omega, V_{GE} = 15V, \\ &Inductive \ Load, T_{C} = 25^\circC \\ &V_{CC} = 300 V, I_{C} = 300A, \\ &R_{G} = 10\Omega, V_{GE} = 15V, \\ &Inductive \ Load, T_{C} = 125^\circC \\ &V_{CC} = 300 V, V_{GE} = 15V \\ & @T_{C} = 100^\circC \end{split}$	 	0.21 0.43 2.43 13 0.3 0.23 0.46 4.1 15 260 990	 	us us mJ us us us us mJ mJ us mJ c
t <u>r</u> t <u>d(off)</u> t <u>f</u> Eon Eoff t <u>d(on)</u> t <u>r</u> t <u>d(off)</u> t <u>f</u> Eon Eoff T _{sc}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Short Circuit Withstand Time	$R_{G} = 10\Omega, V_{GE} = 15V,$ Inductive Load, T _C = 25°C $V_{CC} = 300 V, I_{C} = 300A,$ $R_{G} = 10\Omega, V_{GE} = 15V,$ Inductive Load, T _C = 125°C	 10	0.21 0.43 2.43 13 180 0.3 0.23 0.46 4.1 15 260 	 	us us mJ mJ us us us us mJ mJ us

Electrical Characteristics of DIODE $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V _{FM} C	Diode Forward Voltage	$I_{F} = 300A \qquad \qquad \frac{T_{C} = 25^{\circ}C}{T_{C} = 100^{\circ}C}$		1.9	2.8	V	
			T _C = 100°C		1.8		v
	rr Diode Reverse Recovery Time		$T_{\rm C} = 25^{\circ}{\rm C}$		90	130	
t _{rr}		T _C	T _C = 100°C		130		ns
1	Diode Peak Reverse Recovery		$T_{\rm C} = 25^{\circ}{\rm C}$		32	42	А
Irr	Current		T _C = 100°C		63		
Q _{rr}	Diode Reverse Recovery Charge	-	$T_{\rm C} = 25^{\circ}{\rm C}$		1440	2700	
			T _C = 100°C		4095		nC

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (IGBT Part, per 1/2 Module)		0.14	°C/W
$R_{\theta JC}$	Junction-to-Case (DIODE Part, per 1/2 Module)		0.22	°C/W
$R_{\theta JC}$	Case-to-Sink (Conductive grease applied)	0.035		°C/W
Weight	Weight of Module	240		g

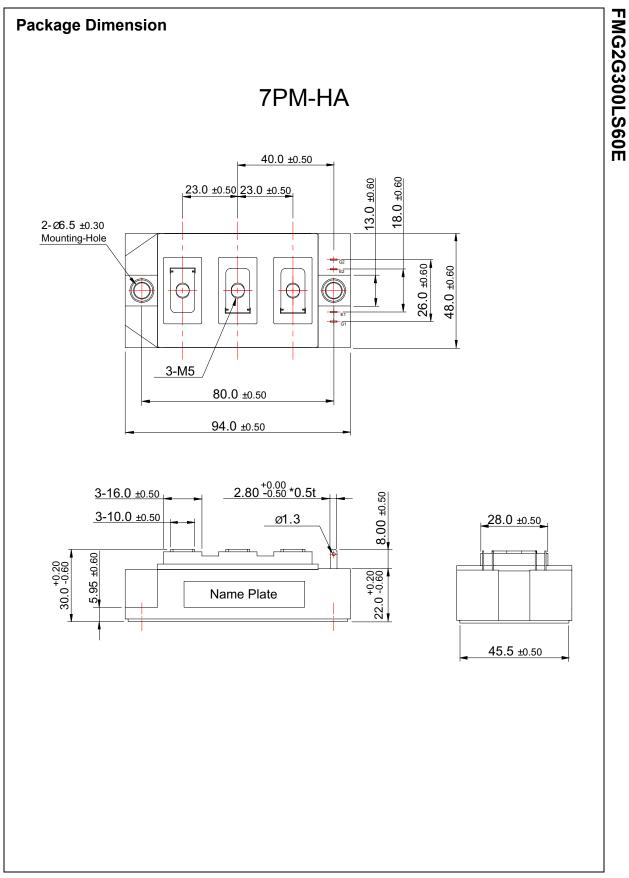


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15 Common Emitter Common Emitter $V_{cc} = 300V, V_{GE} = \pm 15V$ Ic = 300A $T_{c} = 25^{\circ}C - T_{c} = 125^{\circ}C - T_{c} = 125^{\circ}C - T_{c}$ $I_c = 300A$ $V_{cc} = 300V$ Gate - Emitter Voltage, V_{GE} [V] 1000 12 T_c = 25 °C Switching Loss [mJ] 9 Eof 100 6 For 3 10 0 10 20 30 40 50 0 200 400 600 800 1000 Gate Resistance, $\mathrm{R}_{_{\mathrm{G}}}[\Omega]$ Gate Charge, Q_a [nC] Fig 7. Switching Loss vs. Gate Resistance Fig 8. Gate Charge Characteristics Peak Reverse Recovery Current, I $_{\rm rr}$ [A] Reverse Recovery Time, T $_{\rm rr}$ [x10ns] 400 200 Common Cathode Common Cathode di/dt = 600A/#S $V_{GE} = 0V$ T_c^{GE} = 25℃ 100 T_ = 25℃ T_c = 125℃ ····· T_c = 100°C ···· Forward Current, I_F [A] 000 001 1_F [A] ۰Ļ t_{rr} 10 0 5 0.0 0.4 0.8 1.2 1.6 2.0 2.4 2.8 50 300 0 100 150 200 250 Forward Voltage, V_{F} [V] Forward Current, I_F [A] Fig 9. Forward Characteristics (diode) Fig 10. Reverse Recovery Characteristics(diode)

FMG2G300LS60E Rev. A



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